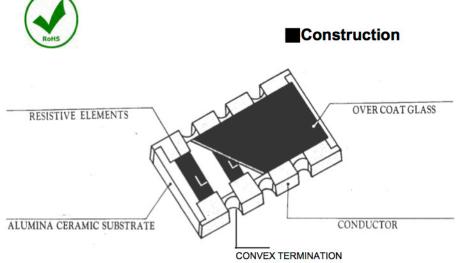
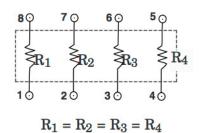
# **Thick Film Chip Resistor Arrays - CN Series**



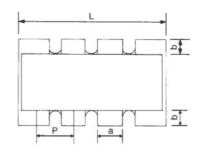


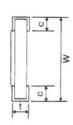


# Features

- Small size and light weight, high density
- Reduction of assembly costs and matching with
- placement machines (automatic placement)
- Reliability, high quality
- Suitable for IR reflow soldering
- Convex

# Dimensions



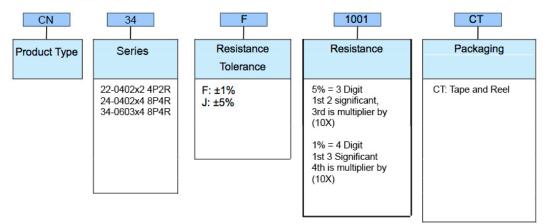


Application	S
- Entertainment	

- Computer & Related Products
- Communication Equipment
- Power Equipment
- Measuring Equipment

Туре	L	w	t	Р	а	b	с		
CN22	1.0±0.1	1.0±0.1	0.35±0.1	0.65±0.05	0.3±0.1	0.15±0.1	0.25±0.2		
CN24	2.0±0.1	1.0±0.1	0.4±0.1	0.5±0.05	0.3±0.1	0.15±0.1	0.25±0.2		
CN34	3.2±0.1	1.6±0.15	0.55±0.1	0.8±0.5	0.45±0.1	0.3±0.2	0.3±0.2		

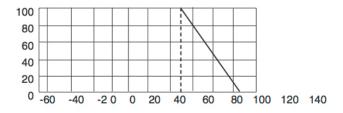
#### Part Numbering



Note: Cal-Chip has completed the Lead-Free transition. All parts shipped will be Lead-Free. The customer designator of "LF" is no longer available.

# Derating Curve





The resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with curve to the left.

# Rated Voltage

The value of rated voltage shall be determined from formula (1).

 $E = \sqrt{P \times R}....(1)$ 

E = Rated Voltage (V)P = Power Rating (W)

 $R = Nominal Resistance (\Omega)$ 

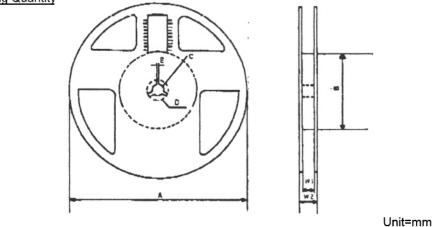
# Electrical/Machine Characteristics and Testing Methods

ltem	Specifications	Test Methods			
Temperature Coefficient	TCR: ±200 ppm	Inspection Temp. Cold: +25°C~-55°C Hot: +25°C~+125°C			
Short Time Overload	±(2%+0.05Ω)	1. Apply 2.5 x rated voltage for 5 sec. 2. Wait 30 minutes 3. Measure resistance value			
Load Life	±(3%+0.05Ω)	<ol> <li>Dwell in chamber at 70±2°C for ON: 90 min. at rated voltage; then OFF: 30 min.</li> <li>Perform 1,000 hours cyclically</li> </ol>			
Load Life in Humidity	±(3%+0.05Ω)	1. Dwell in humidity chamber at 40 ±2°C and 95% RH for ON: 90 min. at rated voltage; then OFF: 30 min. 2. Perform 1.,000 hours cyclically			
Temperature Cycling	±(1%+0.05Ω)	155±3°C~125±3°C, make 5 cycles. 2. Released 1 hour in room temp., then measure value.			
Effect of Soldering	±(2.5%+0.05Ω) Non-damage by machinery	<ol> <li>Immersed in molten solder at 270±5°C for 10±.01 sec.</li> <li>Released 1 hour in room temp., then measure value.</li> </ol>			
Solderability	95% coverage min.	<ol> <li>Immersed in rosin solution for 5~10 seconds.</li> <li>Re-immersed in solder pot at 230±5°C for 3±0.5 sec</li> </ol>			
Intermittent Overload	±(5%+0.1Ω)	<ol> <li>Perform 10,000 voltage cycles as follows: ON (2.5 x rated voltage or current) 1 sec. and OFF 25 sec.</li> <li>Released 30 min. without loading.</li> <li>Measure resistance.</li> </ol>			
Dielectric Withstanding Voltage	No evidence of mechanical damage	Apply 300VAC for 1 second			
Insulation Resistance	10 <sup>8</sup> Ω min	Apply 100VDC.			

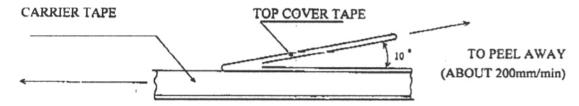
Packaging



Reel Specifications & Packaging Quantity

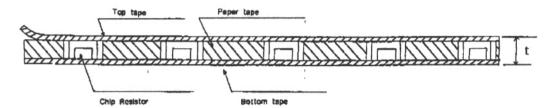


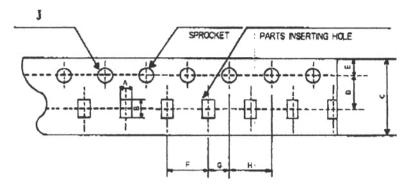
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Туре	Α	В	С	D	E	W1	W2
CN22	Φ178±2.0	Φ80±2.0	Φ13±0.5	Ф21.0	2.0±0.5	9.0±1.0	11.4±2.0
CN24	Φ178±2.0	Φ80±2.0	Φ13±0.5	Ф21.0	2.0±0.5	10.0±1.0	12.5±1.0
CN34	Φ178±2.0	Φ80±2.0	Φ13±0.5	Ф21.0	2.0±0.5	10.0±1.0	12.5±1.0



The top fixed tape for each carrier shall have an adhesion peel strength of 10 to 50G, measure method is shown above to peel away.

**Taping Specification** 





U										Unit=mm	
Туре		A	В	С	D	E	F	G	Н	J	t
CN22 CN24	10000	2.0±0.15	2.4±0.2	8.0±0.2	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	.5±0.1/0	.84±0.01
CN34	5000	2.0±0.2	3.6±0.2	8.0±0.1	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5±0.1	1.0